Notice for TAIYO YUDEN Products

[For High Quality and/or Reliability Equipment (Automotive Electronic Equipment / Industrial Equipment)]

Please read this notice before using the TAIYO YUDEN products.

I REMINDERS

Product information in this catalog is as of October 2018. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), medical equipment classified as Class I or II by IMDRF, industrial equipment, and automotive interior applications, etc. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, medical equipment classified as Class III by IMDRF).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

Automotive Application Guide

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. When using our products for automotive electronic equipment, please be sure to check such application categories and use our products accordingly. Should you have any questions on this matter, please contact us.

Category	Automotive Electronic Equipment (Typical Example)
	Engine ECU (Electronically Controlled Fuel Injector) Cruise Control Unit
	• 4WS (4 Wheel Steering)
POWERTRAIN	Automatic Transmission
	Power Steering
	HEV/PHV/EV Core Control (Battery, Inverter, DC-DC)
	Automotive Locator (Car location information providing device), etc.
	ABS (Anti-Lock Brake System)
SAFETY	ESC (Electronic Stability Control)
57 (i E i i	• Airbag
	ADAS (Equipment that directly controls running, turning and stopping), etc.
	• Wiper
	Automatic Door
	Power Window
	Keyless Entry System
BODY & CHASSIS	Electric Door Mirror
	Interior Lighting LED Headlight
	• TPMS (Tire Pressure Monitoring System)
	Anti-Theft Device (Immobilizer), etc.
	Car Infotainment System
	• ITS/Telematics System
INFOTAINMENT	Instrument Cluster
	• ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain), etc.

WIRE-WOUND CHIP INDUCTORS (LB SERIES)



PART NUMBE	R				*Operating Temp. :	-40~105°C (Including self-generated heat)
	Δ 2 0 1) ③	2 T 1 ④		M △ â ⑦	Δ= ⑧	Blank space
①Series name					④Packaging	
Code	Code Series name			Code	Packaging	
LB	LB Wound chip inductor			-	Т	Taping
②Characteristics	5				⑤Nominal induct	ance
Code	C	haracteristic			Code	Newinel industry of [41]
$\Delta\Delta$	$\Delta\Delta$ Standard				(example)	Nominal inductance[µH]
ΔC	High current			-	1R0	1.0
ΔR	△R Low Rdc			-	100	10
				-	101	100
@ - /.						

③Dimensions(L×W)

Code	Type(inch)	Dimensions (L × W) [mm]
2012	2012(0805)	2.0 × 1.25
2016	2016(0806)	2.0 × 1.6
2518	2518(1007)	2.5 × 1.8
3218	3218(1207)	3.2 × 1.8
3225	3225(1210)	3.2 × 2.5

④Packaging	
Code	Packaging
Т	Taping

Code (example)	Nominal inductance[<i>µ</i> H]
1R0	1.0
100	10
101	100

※R=Decimal point

6 Inductance tolerance

Code	Inductance tolerance
K	±10%
М	±20%

(7)Special code

Jopeolai eeae	
Code	Special code
Δ	Standard
R	Low Rdc type
IN IN	Low ruc type

⑧Internal code

Code	Internal code
V	Inductor for Industrial and Automotive

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY





Surface Mounting

Recommended Land Patterns



Туре	A	В	С
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3218	0.85	1.7	2.0
3225	0.85	1.7	2.7
			Unit · mm

Туре		w T	Ŧ		Standard quantity [pcs]		
туре	L	vv	I	e	Paper tape	Embossed tape	
LB 2012 LB C2012 LB R2012	2.0 ± 0.2 (0.079 ± 0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5 ± 0.2 (0.020 ± 0.008)	-	3000	
LB 2016 LB C2016	2.0 ± 0.2 (0.079 ± 0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5 ± 0.2 (0.020 ± 0.008)	-	2000	
LB 2518 LB C2518 LB R2518	2.5 ± 0.2 (0.098 ± 0.008)	1.8 ± 0.2 (0.071 ± 0.008)	1.8±0.2 (0.071±0.008)	0.5 ± 0.2 (0.020 ± 0.008)	_	2000	
LB 3218	3.2 ± 0.2 (0.128 \pm 0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.6 ± 0.2 (0.024 ± 0.008)	-	2000	
LB C3225	3.2±0.2 (0.128±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	_	1000	
						Unit:mm(inch)	

INDUCTORS STANDARD INDUCTORS

All the Wire-wound Chip Inductors of the catalog lineup are RoHS compliant.

Note)

• The exchange of individual specifications is necessary depending on the application and circuit condition. Please contact Taiyo Yuden sales channels.

- *2: Industrial products and Medical products
 - Please consult with TAIYO YUDEN's official sales channel for the details of the product specification , etc.,
 - and please review and approve TAIYO YUDEN's product specification before ordering.

Please be sure to contact us for further information before using the products for automotive electronic equipment.

Part number	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2012T1R0M V	1.0	±20%	100	0.15	405	7.96	*2
LB 2012T2R2M V	2.2	±20%	80	0.23	260	7.96	*2
LB 2012T3R3M V	3.3	±20%	55	0.30	235	7.96	*2
LB 2012T4R7M V	4.7	±20%	45	0.40	190	7.96	*2
LB 2012T6R8M V	6.8	±20%	38	0.47	135	7.96	*2
LB 2012T100[] V	10	±10%, ±20%	32	0.70	120	2.52	*2
LB 2012T100[RV	10	±10%, ±20%	32	0.50	120	2.52	*2
LB 2012T150[] V	15	±10%, ±20%	28	1.3	100	2.52	*2
LB 2012T220[] V	22	±10%, ±20%	16	1.7	80	2.52	*2
LB 2012T470[] V	47	±10%, ±20%	11	3.7	60	2.52	*2
LB 2012T680[] V	68	±10%, ±20%	10	6.0	50	2.52	*2
LB 2012T101[] V	100	±10%, ±20%	8	7.0	45	0.796	*2

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB C2012T1R0M V	1.0	±20%	100	0.19	620	7.96	*2
LB C2012T2R2M V	2.2	±20%	70	0.33	430	7.96	*2
LB C2012T4R7M V	4.7	±20%	45	0.50	295	7.96	*2
LB C2012T100[] V	10	±10%, ±20%	40	1.2	200	2.52	*2
LB C2012T220[] V	22	±10%, ±20%	16	3.7	130	2.52	*2
LB C2012T470[] V	47	±10%, ±20%	11	5.8	90	2.52	*2

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB R2012T1R0M V	1.0	±20%	100	0.07	400	7.96	*2
LB R2012T2R2M V	2.2	±20%	80	0.13	260	7.96	*2
LB R2012T4R7M V	4.7	±20%	45	0.24	200	7.96	*2
LB R2012T100[] V	10	±10%, ±20%	32	0.36	150	2.52	*2
LB R2012T220[] V	22	±10%, ±20%	16	1.0	100	2.52	*2
LB R2012T470[] V	47	±10%, ±20%	11	1.7	75	2.52	*2
LB R2012T101[] V	100	±10%, ±20%	8	4.0	50	0.796	*2

2016(0806)type

Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 2016T1R0M V	1.0	±20%	100	0.09	490	7.96	*2
LB 2016T1R5M V	1.5	±20%	80	0.11	380	7.96	*2
LB 2016T2R2M V	2.2	±20%	70	0.13	375	7.96	*2
LB 2016T3R3M V	3.3	±20%	55	0.20	285	7.96	*2
LB 2016T4R7M V	4.7	±20%	45	0.25	225	7.96	*2
LB 2016T6R8M V	6.8	±20%	38	0.35	200	7.96	*2
LB 2016T100[] V	10	±10%, ±20%	32	0.50	155	2.52	*2
LB 2016T150[] V	15	±10%, ±20%	28	0.70	130	2.52	*2
LB 2016T220[] V	22	±10%, ±20%	16	1.0	105	2.52	*2
LB 2016T330[] V	33	±10%, ±20%	14	1.7	85	2.52	*2
LB 2016T470[] V	47	±10%, ±20%	11	2.4	70	2.52	*2
LB 2016T680 V	68	±10%, ±20%	10	3.0	55	2.52	*2
LB 2016T101 V	100	±10%, ±20%	8	4.5	40	0.796	*2

Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2016T1R0M V	1.0	±20%	100	0.10	690	7.96	*2
LB C2016T1R5M V	1.5	±20%	80	0.15	600	7.96	*2
LB C2016T2R2M V	2.2	±20%	70	0.20	520	7.96	*2
LB C2016T3R3M V	3.3	±20%	55	0.27	410	7.96	*2
LB C2016T4R7M V	4.7	±20%	45	0.37	355	7.96	*2
LB C2016T6R8M V	6.8	±20%	38	0.59	290	7.96	*2
LB C2016T100[] V	10	±10%, ±20%	32	0.82	245	2.52	*2
LB C2016T150[] V	15	±10%, ±20%	28	1.2	200	2.52	*2
LB C2016T220[] V	22	±10%, ±20%	16	1.8	165	2.52	*2
LB C2016T330[] V	33	±10%, ±20%	14	2.8	135	2.52	*2
LB C2016T470[] V	47	±10%, ±20%	11	4.3	110	2.52	*2
LB C2016T680[] V	68	±10%, ±20%	10	7.0	95	2.52	*2
LB C2016T101[] V	100	$\pm 10\%$, $\pm 20\%$	8	8.0	75	0.796	*2

• [] Please specify the Inductance tolerance code(K or M)

•LB、LBCseries

X)Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

LBRseries

X)Rated Current: The maximum DC value having inductance decrease within 20 % and temperature increase within 20 degC by the application of DC bias.

2518(1007)type

Part number	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA](max.)	Measuring frequency [MHz]	Note
LB 2518T1R0M V	1.0	±20%	100	0.06	665	7.96	*2
LB 2518T1R5M V	1.5	±20%	80	0.07	405	7.96	*2
LB 2518T2R2M V	2.2	±20%	68	0.09	340	7.96	*2
LB 2518T3R3M V	3.3	±20%	54	0.11	280	7.96	*2
LB 2518T4R7M V	4.7	±20%	46	0.13	240	7.96	*2
LB 2518T4R7MRV	4.7	±20%	46	0.10	235	7.96	*2
LB 2518T6R8M V	6.8	±20%	38	0.15	195	7.96	*2
LB 2518T100 V	10	±10%, ±20%	30	0.25	165	2.52	*2
LB 2518T150 V	15	±10%, ±20%	23	0.32	145	2.52	*2
LB 2518T220[] V	22	±10%, ±20%	19	0.50	115	2.52	*2
LB 2518T330[] V	33	±10%, ±20%	15	0.70	95	2.52	*2
LB 2518T470 V	47	±10%, ±20%	12	0.95	85	2.52	*2
LB 2518T680[] V	68	±10%, ±20%	9.5	1.5	70	2.52	*2
LB 2518T101[] V	100	±10%, ±20%	9.0	2.1	60	0.796	*2
LB 2518T151[] V	150	±10%, ±20%	7.0	3.2	45	0.796	*2
LB 2518T221[] V	220	±10%, ±20%	5.5	4.5	40	0.796	*2
LB 2518T331[] V	330	±10%, ±20%	4.5	7.0	30	0.796	*2
LB 2518T471[] V	470	±10%, ±20%	3.5	10	25	0.796	*2
LB 2518T681[] V	680	±10%, ±20%	3.0	17	20	0.796	*2
LB 2518T102 V	1000	±10%, ±20%	2.4	24	15	0.252	*2

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB C2518T1R0M V	1.0	±20%	100	0.080	775	7.96	*2
LB C2518T1R0MRV	1.0	±20%	100	0.065	890	7.96	*2
LB C2518T1R5M V	1.5	±20%	80	0.110	730	7.96	*2
LB C2518T2R2M V	2.2	±20%	68	0.130	630	7.96	*2
LB C2518T3R3M V	3.3	±20%	54	0.160	560	7.96	*2
LB C2518T4R7M V	4.7	±20%	41	0.200	510	7.96	*2
LB C2518T6R8M V	6.8	±20%	38	0.300	420	7.96	*2
LB C2518T100 V	10	±10%, ±20%	30	0.360	375	2.52	*2
LB C2518T150[] V	15	±10%, ±20%	23	0.650	285	2.52	*2
LB C2518T220[] V	22	±10%, ±20%	19	0.770	250	2.52	*2
LB C2518T330[] V	33	±10%, ±20%	15	1.50	185	2.52	*2
LB C2518T470[] V	47	±10%, ±20%	12	1.90	165	2.52	*2
LB C2518T680 V	68	±10%, ±20%	9.5	2.80	140	2.52	*2
LB C2518T101 V	100	±10%, ±20%	9.0	3.70	125	0.796	*2
LB C2518T151[] V	150	±10%, ±20%	7.0	6.10	95	0.796	*2
LB C2518T221[] V	220	±10%, ±20%	5.5	8.40	80	0.796	*2
LB C2518T331[] V	330	±10%, ±20%	4.5	12.3	65	0.796	*2
LB C2518T471 V	470	±10%, ±20%	3.5	22.0	50	0.796	*2
LB C2518T681[] V	680	±10%, ±20%	3.0	28.0	45	0.796	*2

Part number	Nominal inductance [Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB R2518T1R0M V	1.0	±20%	100	0.045	960	7.96	*2
LB R2518T2R2M V	2.2	±20%	68	0.07	480	7.96	*2
LB R2518T4R7M V	4.7	±20%	45	0.10	345	7.96	*2
LB R2518T100[] V	10	±10%, ±20%	30	0.19	235	2.52	*2
LB R2518T220 V	22	±10%, ±20%	19	0.44	175	2.52	*2
LB R2518T470[] V	47	±10%, ±20%	11	0.84	120	2.52	*2
LB R2518T101[] V	100	±10%, ±20%	9	1.89	80	0.796	*2

3218(1207)type

Part number	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LB 3218T1R0M V	1.0	±20%	100	0.06	1,075	7.96	*2
LB 3218T1R5M V	1.5	±20%	80	0.07	860	7.96	*2
LB 3218T2R2M V	2.2	±20%	68	0.09	775	7.96	*2
LB 3218T3R3M V	3.3	±20%	54	0.11	560	7.96	*2
LB 3218T4R7M V	4.7	±20%	41	0.13	550	7.96	*2
LB 3218T6R8M V	6.8	±20%	40	0.17	380	7.96	*2
LB 3218T100[] V	10	±10%, ±20%	30	0.25	340	2.52	*2
LB 3218T150[] V	15	±10%, ±20%	25	0.32	300	2.52	*2
LB 3218T220[] V	22	±10%, ±20%	19	0.49	255	2.52	*2
LB 3218T330[] V	33	±10%, ±20%	15	0.75	215	2.52	*2
LB 3218T470[] V	47	±10%, ±20%	12	0.92	205	2.52	*2
LB 3218T680[] V	68	±10%, ±20%	11	1.49	145	2.52	*2
LB 3218T101[] V	100	±10%, ±20%	8.0	2.4	140	0.796	*2
LB 3218T151[] V	150	±10%, ±20%	7.0	3.2	105	0.796	*2
LB 3218T221[] V	220	±10%, ±20%	5.0	5.4	80	0.796	*2
LB 3218T331[] V	330	±10%, ±20%	4.0	7.0	65	0.796	*2
LB 3218T471[] V	470	±10%, ±20%	3.5	14	54	0.796	*2
LB 3218T681[] V	680	±10%, ±20%	3.0	17	45	0.796	*2
LB 3218T102[] V	1000	±10%, ±20%	2.4	27	39	0.252	*2

• [] Please specify the Inductance tolerance code(K or M)

·LB、LBCseries

*) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

LBRseries

X) Rated Current: The maximum DC value having inductance decrease within 20 % and temperature increase within 20 degC by the application of DC bias.

PART NUMBER

3225(1210)type

Part number	Nominal inductance [µ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
B C3225T1R0MRV	1.0	±20%	250	0.055	1,100	0.1	*2
B C3225T1R5MRV	1.5	±20%	220	0.060	1,000	0.1	*2
B C3225T2R2MRV	2.2	±20%	190	0.080	930	0.1	*2
B C3225T3R3MRV	3.3	±20%	160	0.095	820	0.1	*2
B C3225T4R7MRV	4.7	±20%	70	0.100	680	0.1	*2
B C3225T6R8MRV	6.8	±20%	50	0.120	620	0.1	*2
B C3225T100[]RV	10	±10%, ±20%	23	0.133	540	0.1	*2
B C3225T150[]RV	15	±10%, ±20%	20	0.195	420	0.1	*2
B C3225T220[]RV	22	±10%, ±20%	17	0.27	330	0.1	*2
B C3225T330[]RV	33	±10%, ±20%	13	0.41	300	0.1	*2
B C3225T470[]RV	47	±10%, ±20%	10	0.67	220	0.1	*2
B C3225T680[]RV	68	±10%, ±20%	8	1.0	190	0.1	*2
B C3225T101∏RV	100	±10%, ±20%	6	1.4	150	0.1	*2

•LB、LBCseries

X) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

Derating of Rated Current

LB series

Derating of current is necessary for LB series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PACKAGING

1Minimum Quantity		
	Standard Qu	antity [pcs]
Туре	Paper Tape	Embossed Tape
LB C3225	_	1000
CB C3225		1000
LB 3218	—	2000
LB R2518		
LB C2518		
LB 2518	-	2000
CB 2518		
CB C2518		
LBM2016		
LB C2016		
LB 2016	—	2000
CB 2016		
CB C2016		
LB 2012		
LB C2012		
LB R2012	—	3000
CB 2012		
CB C2012		
CB L2012	4000	_
LB 1608	4000	-
LBMF1608	_	3000
CBMF1608		0000

2 Tape material



This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

i_wound_CB_LB_pack_e-E05R01



③Taping Dimensions

Embossed Tape (0.315 inches wide)



T	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	А	В	F	Т	К
LBM2016	1.75 ± 0.1 (0.069 ± 0.004)	2.1±0.1 (0.083±0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB C3225 CB C3225	2.8±0.1 (0.110±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	4.0max. (0.157max.)
LB 3218	2.1±0.1 (0.083±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608 CBMF1608	$ \begin{array}{r} 1.1 \pm 0.1 \\ (0.043 \pm 0.004) \end{array} $	1.9 ± 0.1 (0.075 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.25±0.05 (0.010±0.002)	1.2max. (0.047max.)

Unit:mm(inch)

Card board carrier tape (0.315 inches wide)



Tune	Chip	cavity	Insertion pitch	Tape thickness
Туре	A	В	F	Т
CB L2012	1.55 ± 0.1	2.3±0.1	4.0±0.1	1.1max.
CB L2012	(0.061 ± 0.004)	(0.091 ± 0.004)	(0.157 ± 0.004)	(0.043max.)
1.5. 1000	1.0 ± 0.1	1.8±0.1	4.0±0.1	1.1max.
LB 1608	(0.039 ± 0.004)	(0.071 ± 0.004)	(0.157 ± 0.004)	(0.043max.)
				l lucit : mama (im ala)

Unit:mm(inch)





6 Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

RELIABILITY DATA

1.Operating temper	ature Range							
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series	$-40 \sim +105^{\circ}$ C (Including self-generated heat)						
	LBM Series							
Test Methods and Remarks	Including self-generated heat							
2. Storage Tempera	ture Range(after soldering)							
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series	-40~+85°C						
	LBM Series							
Test Methods and Remarks								
3.Rated Current								
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series	Within the specified tolerance						
	LBM Series							
4.Inductance								
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series	Within the specified tolerance						
	LBM Series							
Test Methods and	LB·LBC·LBR·CB·CBC·LBM Series							
Remarks	Measuring equipment :LCR Mater (HP4285A or its e	quivalent)						
-								
5.Q								
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series							
	LBM Series	Within the specified tolerance						
Test Methods and	LBM Series							
Remarks	Measuring equipment : LCR Mater(HP4285A or its eq	uivalent)						
6.DC Resistance								
	LB, LBC, LBR Series							
Specified Value	CB, CBC Series	Within the specified tolerance						
	LBM Series							
Test Methods and Remarks	Measuring equipment : DC Ohmmeter(HIOKI 3227 or its equ	ivalent)						

7.Self-Resonant Fr	equency	
	LB, LBC, LBR Series	
Specified Value	CB, CBC Series	Within the specified tolerance
	LBM Series	
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its equivalent)	



8.Temperature Char	8. Temperature Characteristic				
	LBM2016				Inductance change : Within±10%
	LB2012	LBR2012	CB2012	LB2016	
Specified Value	CB2016	LB2518	LBR2518	CB2518	Inductance change : Within±20%
	LBC3225	CBC3225			
	LBC2016	CBC2016	LBC2518	CBC2518	
	LB3218				Inductance change : Within±25%
	LBC2012	CBC2012			Inductance change : Within±35%
	Change of	maximum inductar	nce deviation in	step 1-5	
	Step	Temp	erature(°C)		
	Step	LB,	CB Serie		
Test Methods and	1	20			
Remarks	2		-40		
	3	20(Referen	nce temperature	e)	
	4	+85(Maximum o	operating tempe	rature)	
	5	20			

9.Rasistance to Fle	xure of Substrate		
	LB, LBC, LBR Series		
Specified Value	CB, CBC Series	No damage.	
	LBM Series		
	Warp: 2mm (LB·LBC·LBR·CB·CBC·LBM Series)Test substrate: Board according to JIS C0051Thickness: 1.0mm		
Test Methods and Remarks	Pressing jig		
	R5 45±2mm		

10.Body Strength		
	LB, LBC, LBR Series	No damage.
Specified Value	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB+LBC+LBR+CB+CBC+LBM Applied force : 10N Duration : 10sec.	

11.Adhesion of term	ninal electrode			
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series		No abnormality.	
	LBM Series			
Test Methods and Remarks	LB•LBC•LBR•CB Applied force Duration Test substrate	•CBC•CBL•LBM : 10N to X and Y directions 5 sec. : Printed board		

12.Resistance to vi	bration		
	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.
Specified Value	CB, CBC Series		
	LBM Series		Inductance change : Within $\pm 20\%$ No significant abnormality in appearance.
Test Methods and Remarks	Amplitude : 1.5mm Mounting method : Soldering onto printed board		

13.Drop test				
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	—		
	LBM Series]		

14.Solderability			
Specified Value	LB, LBC, LBR Series		At least 90% of surface of terminal electrode is covered by new
	CB, CBC Series		
	LBM Series		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: Solder temperature : 245±5°C Duration : 5±0.5sec Flux : Methanol solution with 25% of col		ophony

15.Resistance to so	Idering		
	LB, LBC, LBR Series	Inductance change : Within±20%	
Specified Value	CB, CBC Series		
	LBM Series	Inductance change : Within±20%	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: 3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 °C for 5sec.		

16.Resisitance to so	olvent		
	LB, LBC, LBR Series		
Specified Value	CB, CBC Series] –
	LBM Series]
Test Methods and Remarks	Solvent temperature Type of solvent Cleaning conditions	: Room temperature : Isopropyl alcohol : 90s. Immersion and cleaning.	

17.Thermal shock		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM: -40~+85°C, maintain t Recovery : At least 2 hrs of recovery under the sta	imes 30min. ,100 cycle Indard condition after the test, followed by the measurement within 48 hrs.
Remarks		

18.Damp heat life te	est		
Specified Value	LB, LBC, LBR Series		
	CB, CBC Series		Inductance change : Within±20% No significant abnormality in appearance.
	LBM Series		
	Temperature	: 60±2°C	
Test Methods and	Humidity	: 90~95%RH	
Remarks	Duration	: 1000 hrs	
	Recovery	: At least 2 hrs of recovery under th	e standard condition after the test, followed by the measurement within 48 hrs.

19.Loading under da	19.Loading under damp heat life test		
	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.
Specified Value	CB, CBC Series		
	LBM Series		
Test Methods and Remarks	Temperature Humidity Duration Applied current Recovery	: 60±2°C : 90~95%RH : 1000 hrs : Rated current : At least 2 hrs of recovery under the st	andard condition after the test, followed by the measurement within 48 hrs.

20.High temperature	20.High temperature life test		
	LB, LBC, LBR Series		-
Specified Value	CB, CBC Series		Inductance change : Within±20%
	LBM Series		No significant abnormality in appearance.
Test Methods and Remarks	Temperature Duration Recovery	: 85±2°C : 1000 hrs : At least 2 hrs of recovery under the sta	andard condition after the test, followed by the measurement within 48 hrs.

21.Loading at high temperature life test				
	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.	
Specified Value	CB, CBC Series			
	LBM Series] _	
	Temperature	: 85±2°C		
Test Methods and	Duration	: 1000 hrs		
Remarks	Applied current	: Rated current		
	Recovery	: At least 2 hrs of recovery under the sta	andard condition after the test, followed by the measurement within 48 hrs.	

22.Low temperature	22.Low temperature life test			
	LB, LBC, LBR Series		Inductance change : Within±20% No significant abnormality in appearance.	
Specified Value	CB, CBC Series			
	LBM Series			
Test Methods and Remarks	Temperature Duration Recovery	: -40±2°C : 1000 hrs : At least 2 hrs of recovery under the sta	indard condition after the test, followed by the measurement within 48 hrs.	

23.Standard condition		
	LB, LBC, LBR Series	Standard test conditions
	CB, CBC Series	Unless specified, Ambient temperature is $20\pm15^{\circ}$ C and the Relative
Specified Value	LBM Series	humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2°C Relative humidity: 65±5% Inductance value is based on our standard measurement systems.

WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design	1
Precautions	 Operating environment The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive interior applications, etc. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment). Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).

2. PCB Design	
Precautions	 ◆Land pattern design 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.
Technical considerations	PRECAUTIONS [Recommended Land Patterns] Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to those products is reflow soldering only.

3. Consideration	3. Considerations for automatic placement	
Precautions	 Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. 	
Technical considerations	1. When installing products, care should be taken not to apply distortion stress as it may deform the products.	

4. Soldering			
Precautions	 Reflow soldering (LB and CB Types) For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended. Recommended conditions for using a soldering iron Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly. 		
Technical considerations	 Reflow soldering(LB and CB Types) Reflow profile Reflow profile Reflow profile Sec max Peak: 200 90±30sec 30±10sec 30±10sec Heating Time [sec] Recommended conditions for using a soldering iron Components can be damaged by excessive heat where soldering conditions exceed the specified range. 		

5. Cleaning	5. Cleaning	
Precautions	♦Cleaning conditions Washing by supersonic waves shall be avoided.	
Technical considerations	 ♦Cleaning conditions If washed by supersonic waves, the products might be broken. 	

6. Handling	
Precautions	 Handling Keep the inductors away from all magnets and magnetic objects. Breakaway PC boards (splitting along perforations) When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations Please do not give the inductors any excessive mechanical shocks.
Technical considerations	 Handling 1. There is a case that a characteristic varies with magnetic influence. Breakaway PC boards (splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

7. Storage cond	itions
Precautions	 Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions
Technical considerations	 Storage Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.